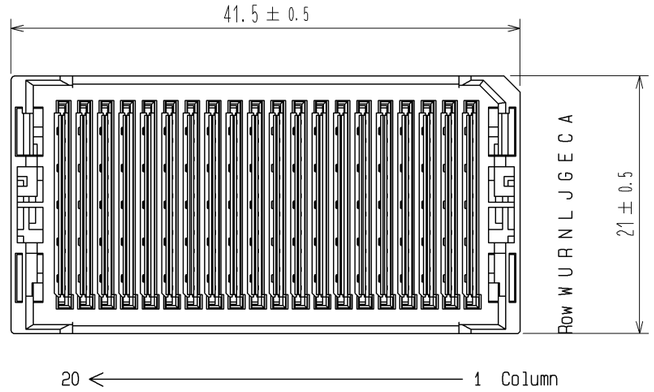


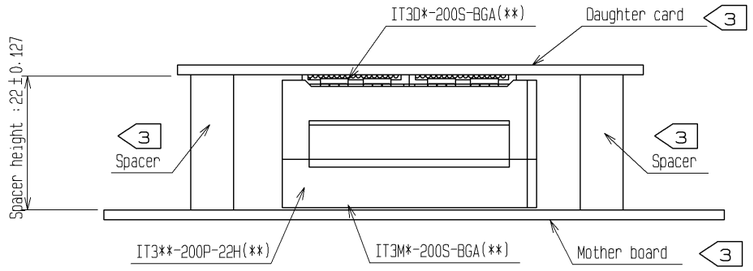
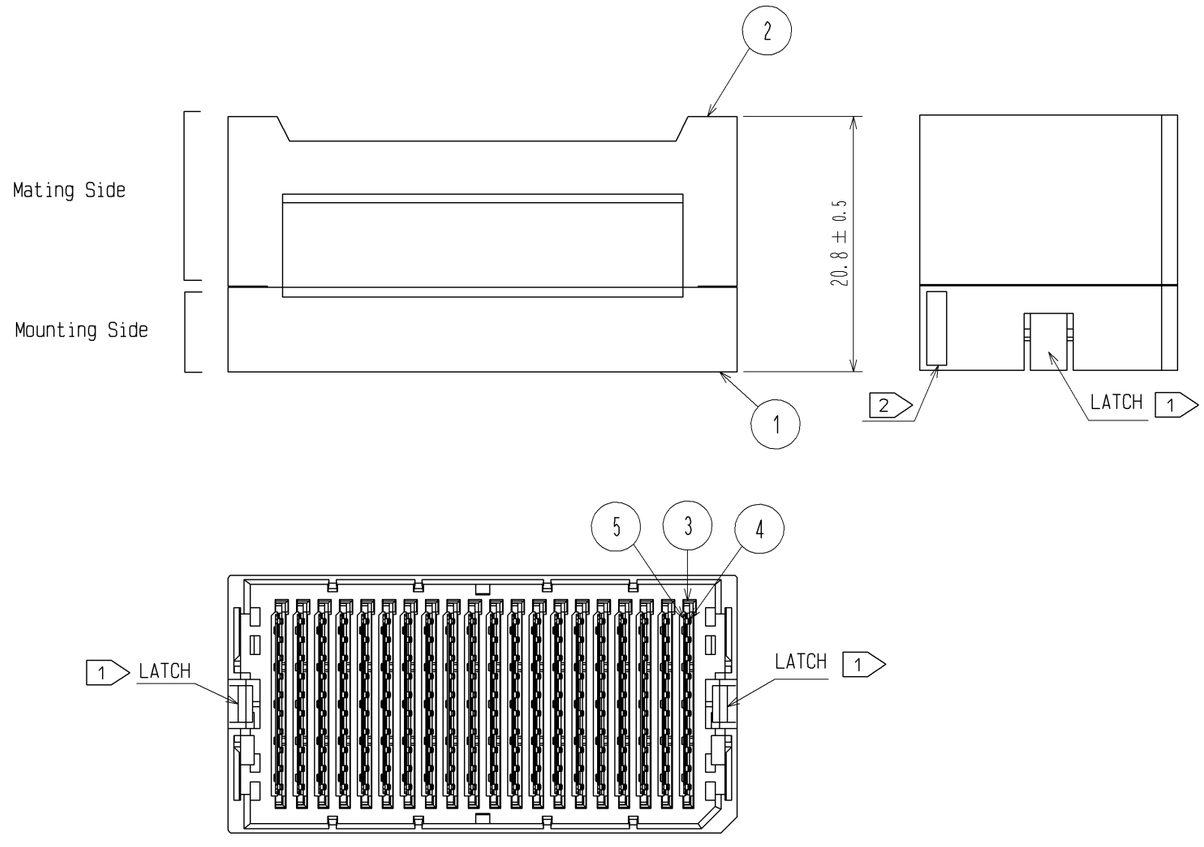
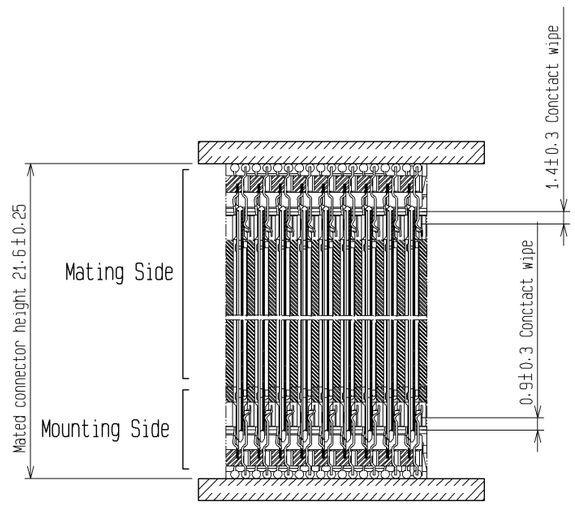


Fig. 1(FREE)





Mating Cross Section (Free)

NOTE. 1 Mounting side is mated with the receptacle:IT3M-200S-BGA(**) and fixed with the latch.
2 Lot No. shall be marked on the indicated position.
3 The indicated mother board and daughter card shall be fastened to the additional reinforcements to prevent the stress on IT3*-200S-BGA(**) solder joints.
4. More information of this product is available in HIROSE document :ETAD-F0347 "IT3 design guideline".
5. This product consists of 200 signal lines and 180 ground lines.
6. 40pcs of this products are packed in a soft tray.
7. Standard package of 80pcs are packaged in a carton box.

NO.	MATERIAL	FINISH, REMARKS	NO.	MATERIAL	FINISH, REMARKS
3	LCP	BLACK UL94V-0			
2	PBT	GRAY UL94V-0	5	Copper Alloy	CONTACT AREA:NICKEL(1.5μm)+GOLD (0.76μm)
1	PBT	BLACK UL94V-0	4	Copper Alloy	CONTACT AREA:NICKEL(1.5μm)+GOLD (0.76μm)

UNITS	SCALE	COUNT	DESCRIPTION OF REVISIONS	DESIGNED	CHECKED	DATE
mm	2 : 1					

HIROSE ELECTRIC CO., LTD.

APPROVED	TM. MATSUO	09. 07. 29	DRAWING NO. EDC3-325918-01
CHECKED	MK. EZAKI	09. 07. 29	PART NO. IT3-200P-22H(03)
DESIGNED	TS. SAITO	09. 07. 29	
DRAWN	TS. SAITO	09. 07. 29	CODE NO. CL636-0209-3-03

△ 1/1